

	Type	L #	Hits	Search Text
1	BRS	L1	76460	composite near2 (sheet pad film layer )
2	BRS	L2	14507	1 and (matrix)
3	BRS	L3	4383	2 and (conductive)
4	BRS	L4	1110	3 and (column)
5	BRS	L5	201	4 and (non-conductive)
6	BRS	L6	67	5 and (laminate)
7	BRS	L7	34	6 and (upper top ) near2 (layer)
8	BRS	L8	26	7 and (lower bottom ) near2 (layer)
9	BRS	L9	12626	composite near2 (sheet pad film layer ) near2 (material)
10	BRS	L10	11	9 and (non-conductive) near3 (matrix)
11	BRS	L11	1158	"composite sheet material"
12	BRS	L12	18	11 and (non-conductive)
13	BRS	L13	3	12 and (matrix)
14	BRS	L14	549	73/774
15	BRS	L15	10	14 and composite near2 (sheet pad film layer )
16	BRS	L16	4	15 and (matri\$5)
17	BRS	L17	546	(non-conductive) near3 (matri\$5)
18	BRS	L18	79	17 and composite near2 (sheet pad film layer structure)
19	BRS	L19	79	18 and (conductive)
20	BRS	L20	28	19 and (column)

	<b>DBs</b>	<b>Time Stamp</b>	<b>Comments</b>	<b>Error Definition</b>	<b>Errors</b>
1	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:22			0
2	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:20			0
3	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:22			0
4	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:26			0
5	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:20			0
6	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:08			0
7	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:09			0
8	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:09			0
9	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:17			0
10	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:22			0
11	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:20			0
12	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:20			0
13	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:21			0
14	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:21			0
15	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:21			0
16	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:21			0
17	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:24			0
18	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:24			0
19	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:22			0
20	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:23			0

	Type	L #	Hits	Search Text
21	BRS	L21	47026	( composite ) near2 (sheet pad material film layer structure).ti.
22	BRS	L22	1	21 and (non-conductive) near3 (matri\$5).clm.
23	BRS	L23	1	22 and (conductive)
24	BRS	L24	14	21 and (non-conductive) near3 (matri\$5)
25	BRS	L26	0	25 and (column)
26	BRS	L25	14	24 and (conductive)
27	BRS	L27	22063	laminate.clm.
28	BRS	L28	3	27 and (non-conductive) near3 (matri\$5).clm.
29	BRS	L29	0	28 and (shear lateral\$4 )
30	BRS	L30	3	28 and (force load pressure strain stress)

	<b>DBs</b>	<b>Time Stamp</b>	<b>Comments</b>	<b>Error Definition</b>	<b>Errors</b>
21	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:24			0
22	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:26			0
23	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:26			0
24	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:28			0
25	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:26			0
26	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:28			0
27	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:28			0
28	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:29			0
29	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:29			0
30	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 15:30			0

	Type	L #	Hits	Search Text
1	BRS	L1	24936	composite near2 (structure sheet pad layer film material).clm.
2	BRS	L2	16	1 and (non-conductive near2 matri\$5)
3	BRS	L3	8	2 and (upper top) near2( layer surface)
4	BRS	L4	7	3 and (lower bottom) near2( layer surface)
5	BRS	L5	2	4 and (column)

	<b>DBs</b>	<b>Time Stamp</b>	<b>Comments</b>	<b>Error Definition</b>	<b>Erro rs</b>
1	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 16:21			0
2	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 16:21			0
3	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 16:23			0
4	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 16:23			0
5	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/30 16:23			0